

FEATURES

- Compatible with TIA/EIA-485-A standard
- 2.5V~5.5V V_{CC1} , 4.5V~5.5V V_{CC2} power supply range, half-duplex
- Bus port ESD protection capacity of over 15kV HBM
- 1/8 unit load, allow up to 256 transceivers on the bus
- Driver Short-circuit protection, receiver open-circuit failure protection
- Low power shutdown function
- Data transmission up to 500kbps in an electric noise environment
- Wide temperature range: $-40^{\circ}\text{C}\sim 125^{\circ}\text{C}$
- Strong anti-noise ability
- High CMTI: $\pm 100\text{kV}/\mu\text{s}$ (typical value)
- Up to 5000 VRMS isolation voltage resistance
- Isolation gate life: >40 years.
- Wide-body SOIC16 package, RoHS compliant

PRODUCT APPEARANCE



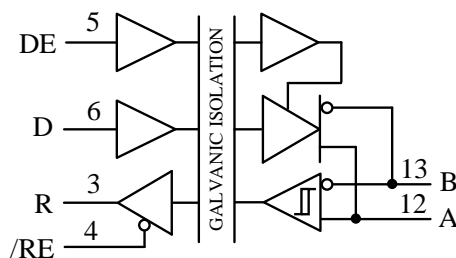
Provide green and environmentally friendly lead-free package

DESCRIPTION

The SIT3485ISO is a capacitive isolated half duplex RS-485 transceiver, and bus port ESD protection capacity of more than 15kV HBM. It is a RS-485 transceiver fully meet the requirements of TIA/EIA-485 standard.

The SIT3485ISO includes a driver and a receiver, both of which can be enabled and closed independently. When both are disabled, both the driver and the receiver output are high resistance state. SIT3485ISO has 1/8 load, which allows 256 SIT3485ISO transceivers to be connected to the same communication bus. It can realize error-free data transmission up to 500kbps.

The SIT3485ISO has the functions of fail-safe, over temperature protection, current-limiting protection, over-voltage protection, etc.



Function module diagram

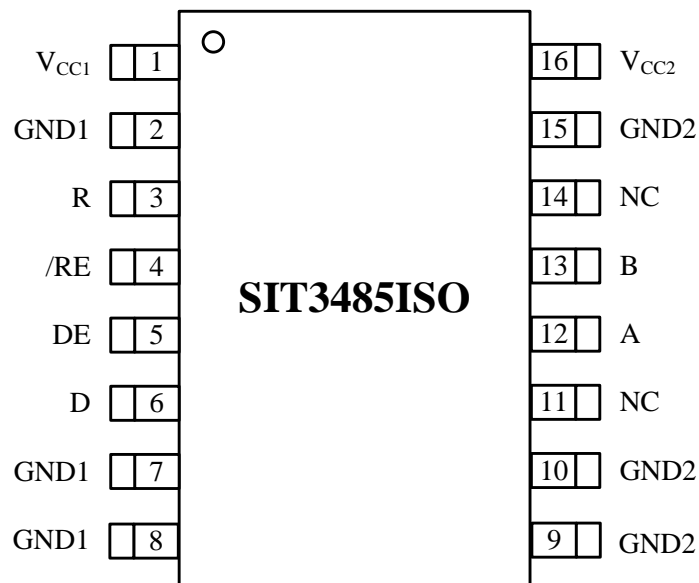
PIN CONFIGURATION


Fig 1 SIT3485ISO pin configuration

PIN DESCRIPTION

PIN	SYMBOL	DESCRIPTION
1	V _{CC1}	Power supply, V _{CC1}
2	GND1	Ground point of power supply V _{CC1}
3	R	Receiver Output. When /RE is low and if A - B ≥ 200mV, R will be high; if A - B ≤ -200mV, R will be low.
4	/RE	Receiver Output Enable. Drive /RE low to enable RO; RO is high impedance when /RE is high. Drive /RE high and DE low to enter low-power shutdown mode.
5	DE	Driver Output Enable. Drive DE high to enable driver outputs. These outputs are high impedance when DE is low. Drive /RE high and DE low to enter low-power shutdown mode.
6	D	Driver Input. With DE high, a low on D forces non-inverting output low and inverting output high. Similarly, a high on D forces non-inverting output high and inverting output low.
7	GND1	Ground point of power supply V _{CC1} .

PIN	SYMBOL	DESCRIPTION
8	GND1	Ground point of power supply V_{CC1} .
9	GND2	Ground point of power supply V_{CC2} .
10	GND2	Ground point of power supply V_{CC2} .
11	NC	No internal connection.
12	A	Non-inverting receiver input and non-inverting driver output.
13	B	Inverting receiver input and inverting driver output.
14	NC	No internal connection.
15	GND2	Ground point of power supply V_{CC2} .
16	V_{CC2}	Power supply, V_{CC2} .

LIMITING VALUES

PARAMETER	SYMBOL	VALUE	UNIT
Supply voltage	V_{CC1}, V_{CC2}	-0.5~+6	V
control port voltage	/RE, DE, D	-0.5~ $V_{CC1}+0.5$	V
Receiver output current	I_o	-10~+10	mA
Bus side input voltage	A, B	-15~+15	V
Virtual junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-65~150	°C

The maximum limit parameters mean that exceeding these values may cause irreversible damage to the device. Under these conditions, it is not conducive to the normal operation of the device. The continuous operation of the device at the maximum allowable rating may affect the reliability of the device. The reference point for all voltages is ground.

DRIVER DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Differential driver output (no load)	V_{OD1}		2.7	5	5.5	V
Differential driver output	V_{OD2}	Fig 2, $R_L = 54 \Omega$	1.5	2.3		V
Change in magnitude of output voltage (NOTE1)	ΔV_{OD}	Fig 2, $R_L = 54 \Omega$	-0.2		0.2	V
Common-mode output voltage	V_{OC}	Fig 2, $R_L = 54 \Omega$	1		3	V
Change in magnitude of common-mode output voltage (NOTE1)	ΔV_{OC}	Fig 2, $R_L = 54 \Omega$			0.2	V
Input high voltage	V_{IH}	DE, D, /RE	2.0			V
Input low voltage	V_{IL}	DE, D, /RE			0.8	V
Logic input current	I_{IN1}	DE, D, /RE	-15		20	μA
Output short-circuit current (VO=HIGH)	I_{OSDH}	DE=/RE=D=1 VA=-7V, VB=12V	-250		250	mA
Output short-circuit current (VO=LOW)	I_{OSDL}	DE=/RE=1, D=0 VA=-7V, VB=12V	-250		250	mA

 (Unless otherwise noted, Temp= T_{MIN} ~ T_{MAX} , Temp=25°C.)

 NOTE1: ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when the D input changes state.

RECEIVER DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Input current (A, B)	I_{IN2}	DE = 0 V, VCC=0 or 5V $V_{IN} = 12 V$			125	μA
		DE = 0 V, VCC=0 or 5V $V_{IN} = -7 V$	-100			μA
Positive input threshold voltage	V_{IT+}	$-7V \leq V_{CM} \leq 12V$			-20	mV

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Reverse input threshold voltage	V_{IT-}	$-7V \leq V_{CM} \leq 12V$	-200			mV
Input hysteresis voltage	V_{hys}	$-7V \leq V_{CM} \leq 12V$		30		mV
Output High voltage	V_{OH}	$I_{OUT} = -4mA,$ $V_{ID} = +200 mV$	$V_{CC1} - 0.4$			V
Output Low voltage	V_{OL}	$I_{OUT} = +4mA,$ $V_{ID} = -200 mV$			0.4	V
Receiver input resistance	R_{IN}	$-7V \leq V_{CM} \leq 12V$	96			k Ω
Receiver short-circuit output current	I_{OSR}	$0 V \leq V_O \leq V_{CC}$			± 150	mA

 (Unless otherwise noted, Temp= $T_{MIN} \sim T_{MAX}$, Temp= $25^{\circ}C$.)

SUPPLY CURRENT

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Supply Current	I_{CC1}	/RE= 0 or 1, DE = 0 or 1, $V_{CC1} = 3.3V$			4.2	mA
		/RE=0 or 1, DE = 0 or 1, $V_{CC1} = 5V$			4.2	mA
	I_{CC2}	/RE= 0 or 1, DE=0, no load			5.8	mA

DRIVER SWITCHING CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Output rising time	t_r	$R_L = 60 \Omega,$ $C_L = 100pF$ (Fig 3 & Fig 4)		12	28	ns
Output falling time	t_f			12	28	ns
Driver propagation delay, low-to-high level	t_{PLH}	$R_L = 27 \Omega,$ (Fig 3 & Fig 4)		16	48	ns
Driver propagation delay, high-to-low level	t_{PHL}			16	48	ns

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
$ t_{PLH} - t_{PHL} $	t_{PDS}			3	13	ns
Output enable time to high level	t_{PZH}	$R_L = 110\Omega$, (Fig 5 & Fig 6)			90	ns
Output enable time to low level	t_{PZL}				90	ns
Output disable time from low level	t_{PLZ}	$R_L = 110\Omega$, (Fig 5 & Fig 6)			85	ns
Output disable time from high level	t_{PHZ}				85	ns

RECEIVER SWITCHING CHARACTERISTICS

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Output rising time	t_r	$C_L = 15pF$ (Fig 7 & Fig 8)			4	ns
Output falling time	t_f				4	ns
Receiver propagation delay, low-to-high level	t_{RPLH}	$C_L = 15pF$ (Fig 7 & Fig 8)		80	160	ns
Receiver propagation delay, high-to-low level	t_{RPHL}			80	160	ns
$ t_{RPLH} - t_{RPHL} $	t_{RPDS}					30
Output enable time to low level	t_{RPZL}	$C_L = 15pF$ (Fig 7 & Fig 8)		15	40	ns
Output enable time to high level	t_{RPZH}	$C_L = 15pF$ (Fig 7 & Fig 8)		15	40	ns
Output disable time from low level	t_{RPLZ}	$C_L = 15pF$ (Fig 7 & Fig 8)		25	55	ns
Output disable time from high level	t_{RPHZ}	$C_L = 15pF$ (Fig 7 & Fig 8)		25	55	ns

FUNCTION TABLE
Transmitter function truth table

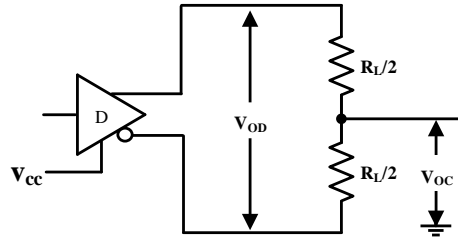
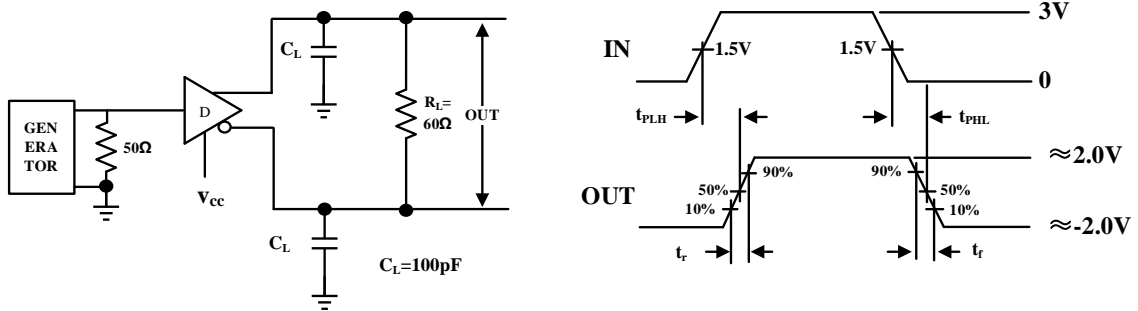
V _{CC1}	V _{CC2}	INPUT	ENABLE INPUT	OUTPUTS	
		(DI)	(DE)	A	B
PU	PU	H	H	H	L
PU	PU	L	H	L	H
PU	PU	X	L	Z	Z
PU	PU	X	OPEN	Z	Z
PU	PU	OPEN	H	H	L
PD	PU	X	X	Z	Z
PU	PD	X	X	Z	Z
PD	PD	X	X	Z	Z

(1) PU = Power up; PD =Power down; H =High level; L=Low level; X = Irrelevant; Z =High impedance.

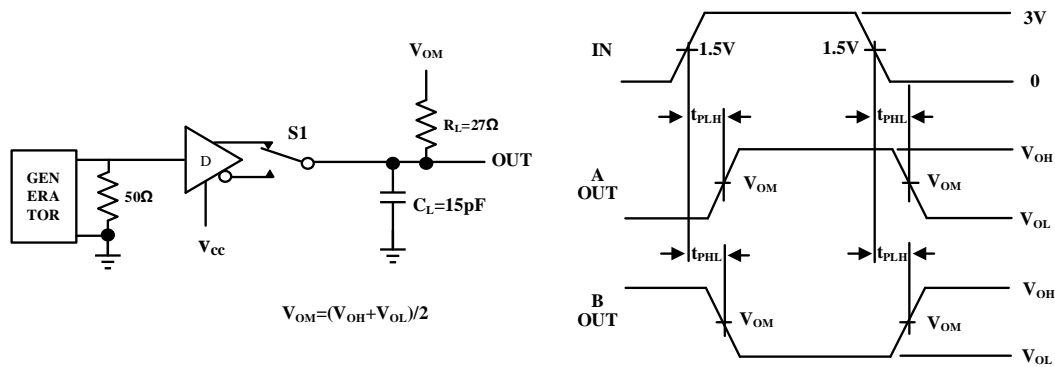
Receiver function truth table

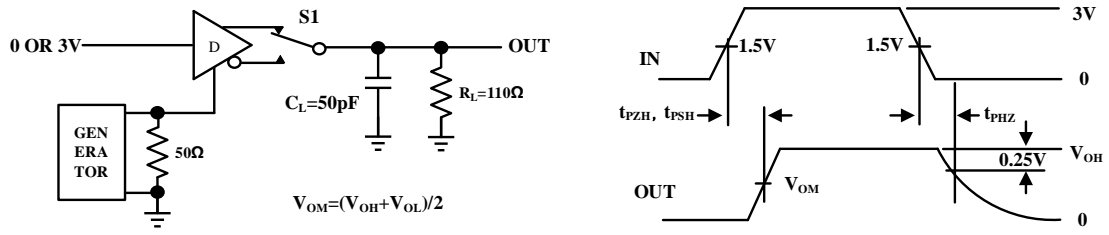
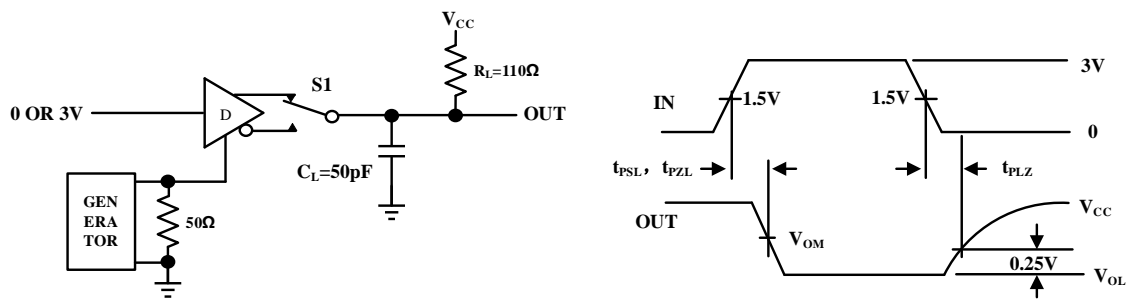
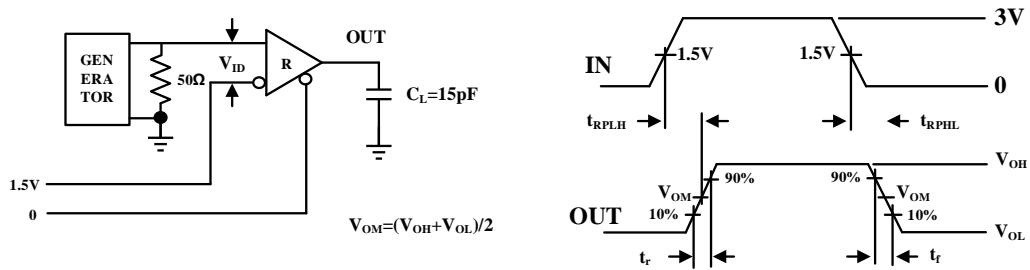
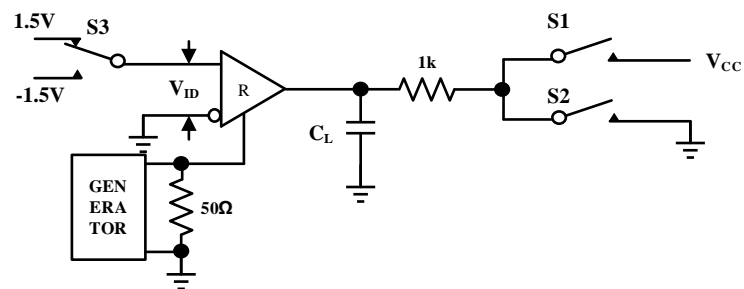
V _{CC1}	V _{CC2}	Differential Input V _{ID} =(V _A -V _B)	Enable (/RE)	Output (R)
PU	PU	-0.02V ≤ V _{ID}	L/OPEN	H
PU	PU	-0.2V < V _{ID} < -0.02V	L/OPEN	?
PU	PU	V _{ID} ≤ -0.2V	L/OPEN	L
PU	PU	X	H	Z
PU	PU	Open circuit	L/OPEN	H
PU	PU	Short circuit	L/OPEN	H
PU	PU	idle	L	H
PD	PU	X	X	Z
PU	PD	X	X	H
PD	PD	X	X	Z

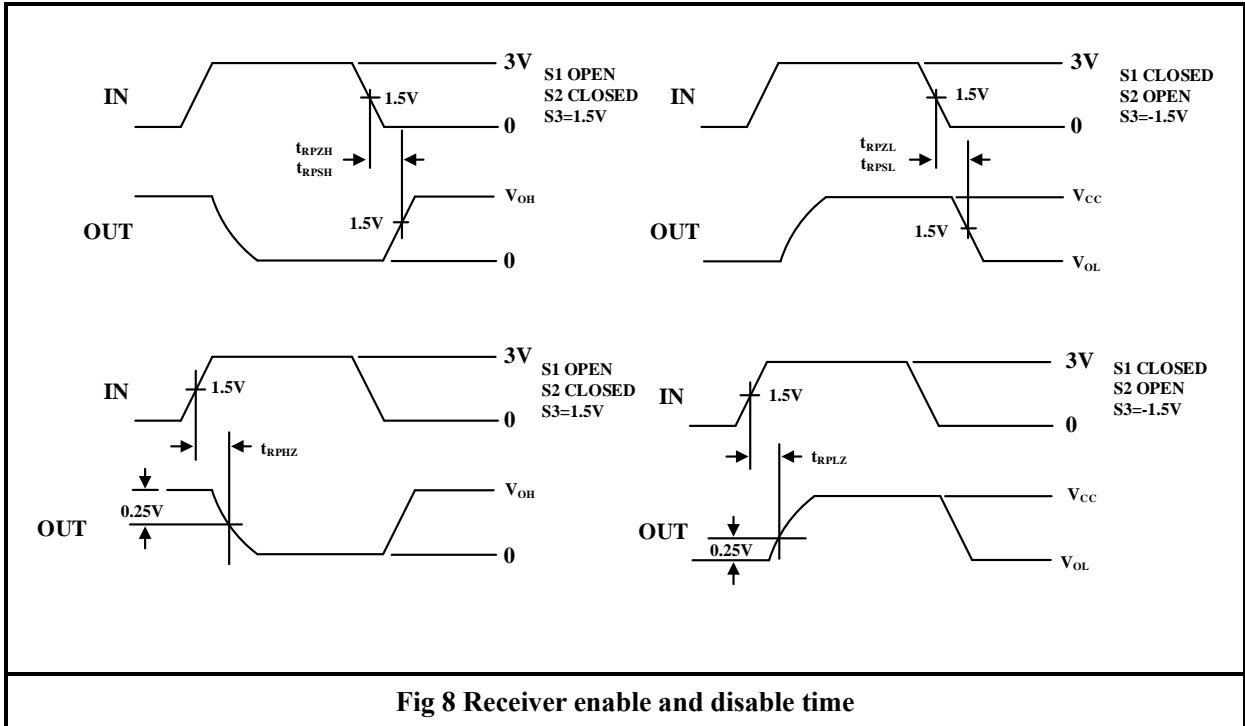
(1) PU=Power up; PD=Power down; H=High level; L=Low level; X=Irrelevant; Z=High impedance; ? = Uncertain.

TEST CIRCUIT

Fig 2 Driver DC test load


CL includes probe and stray capacitance (the same below).

Fig 3 Differential delay and transit time of driver

Fig 4 Drive propagation delay


Fig 5 Drive enable and disable time

Fig 6 Drive enable and disable time

Fig 7 Receiver propagation delay test circuit



Fig 8 Receiver enable and disable time

ADDITIONAL DESCRIPTION**1 Sketch**

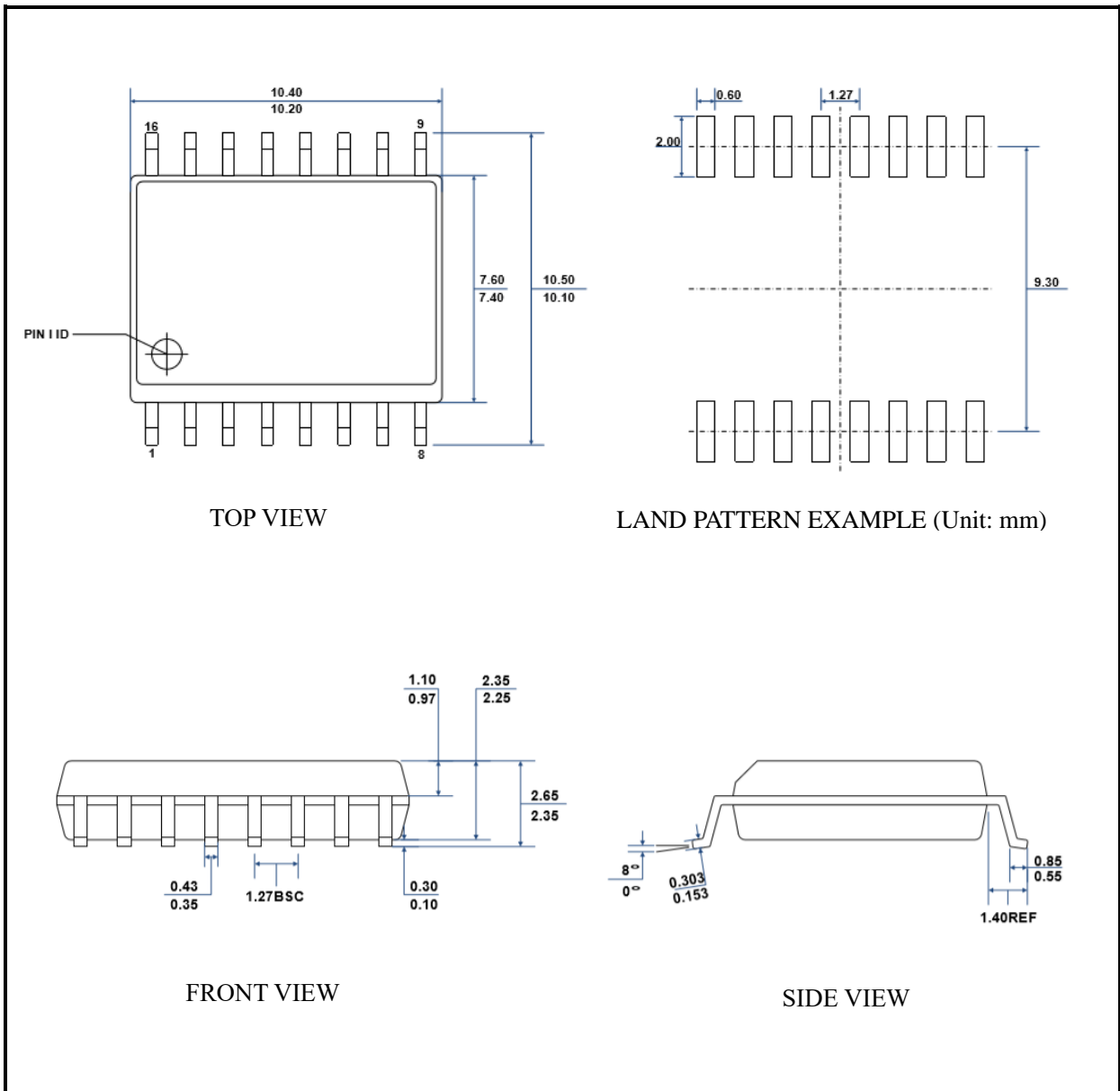
The SIT3485ISO is a capacitive isolated half duplex RS-485 transceiver, and bus port ESD protection capacity of more than 15kV HBM, including a driver and receiver. It has the functions of fail-safe, over-voltage protection, and over-current protection. SIT3485ISO realizes error-free data transmission up to 500kbps.

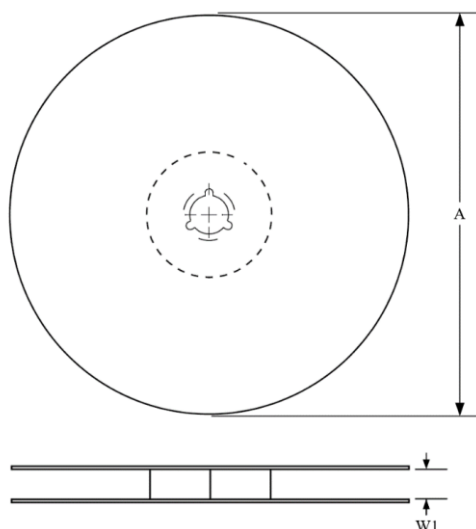
2 Allowing up to 256 transceivers on the Bus

The input impedance of the standard RS485 receiver is 12k Ω (1 unit load), and the standard driver can drive up to 32 unit loads. The receiver of SIT3485ISO transceiver has 1/8 unit load input impedance (96k Ω), which allows up to 256 transceivers to be connected on the same communication bus in parallel. These devices can be combined arbitrarily or with other RS485 transceivers. Any combination of these devices and/or other RS-485 transceivers with a total of 32 unit loads or less can be connected to the line.

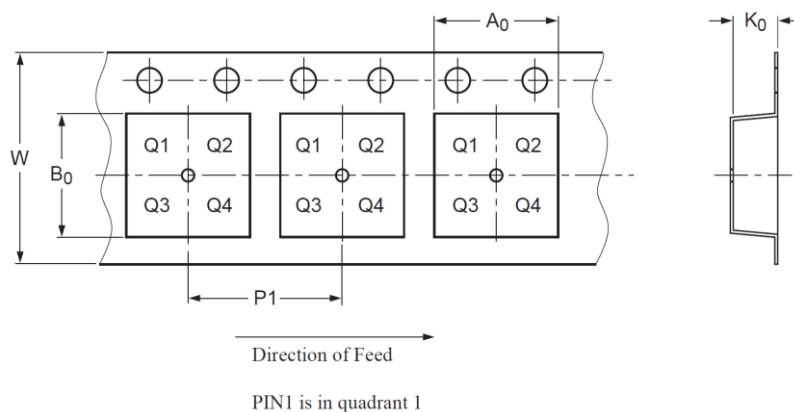
3 Driver output protection

Over-current, overvoltage, and overtemperature protection mechanisms are used to prevent excessive output current and power dissipation caused by faults or bus contention, providing fast short circuit protection over the entire common mode voltage range(refer to typical operating characteristics).

SOIC16-WB WIDE BODY DIMENSIONS


TAPE AND REEL INFORMATION


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

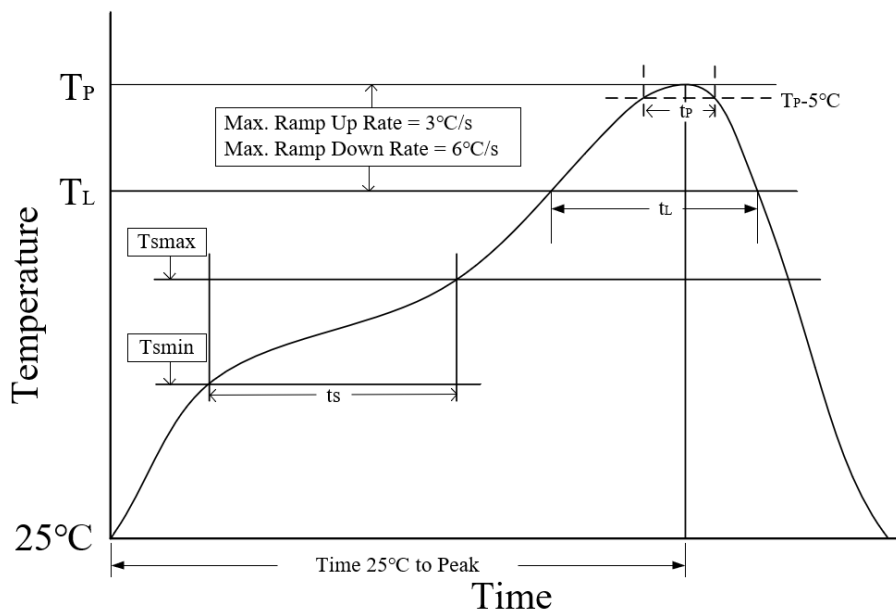


Package type	Reel diameter A (mm)	Tape width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)
SOPW16	330±2.0	16.4 ^{+2.0} / _{+0.0}	10.75±0.1	10.70±0.10	2.80±0.10	12.00±0.10	16.00±0.20

ORDERING INFORMATION

TYPE NUMBER	PACKAGE	PACKING
SIT3485ISO	SOPW16, body wide SOIC8	Tape and reel

SOPW16 is packed with 1000 pieces/disc in braided packaging.

REFLOW SOLDERING


Parameter	Lead-free soldering conditions
Ave ramp up rate (T_L to T_P)	3 °C/second max
Preheat time t_s ($T_{smin}=150\text{ °C}$ to $T_{smax}=200\text{ °C}$)	60-120 seconds
Melting time t_L ($T_L=217\text{ °C}$)	60-150 seconds
Peak temp T_P	260-265 °C
5°C below peak temperature t_P	30 seconds
Ave cooling rate (T_P to T_L)	6 °C/second max
Normal temperature 25°C to peak temperature T_P time	8 minutes max

Important statement

SIT reserves the right to change the above-mentioned information without prior notice.

REVISION HISTORY

Version number	Data sheet status	Revision Date
V1.0	Initial version	December 2022